

05-29-2003

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TO THE ASSISTANT COMMISSIONER FOR

102460696

documents or copy thereof.

1. Name of conveying party(ies). (If multiple assignors, list numerically)

(1) Mitsue Nanbu

2. Name and address of receiving party(ies):

Name: Advantest Corporation

Address: NS Building, 4-1, Nishi-Shinjuku 2-chome, Shinjuku-ku, Tokyo, Japan

Additional name(s) of conveying party(ies) attached?

() Yes (X) No

Additional name(s) of receiving party(ies) attached?

() Yes (X) No

3. Nature of conveyance:

- (X) Assignment
() Merger
() Security Agreement
() Change of Name
() Other:

4. Application number(s) or Patent number(s):

(X) Application(s) filed herewith Execution Date(s):

(X) Patent Application No.: 10/373,919

Filing Date: February 25, 2003

() Patent No.:

Issue Date:

Execution Date: (If multiple assignors, list execution dates in numerical order corresponding to numbers indicated in 1 above)

(1) April 17, 2003

Additional numbers attached? () Yes (X) No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Yasuo Muramatsu

Muramatsu & Associates

Internal Address: Second Floor

Street Address: 7700 Irvine Center Drive, Suite 225

City: Irvine State: CA ZIP: 92618

Attorney's Docket No.: ADVA221.001CP1

7. Total fee (37 CFR 3.41): \$40.00

(X) Enclosed

() Authorized to be charged to deposit account

8. Deposit account number:

Please charge this account for any additional fees which may be required, or credit any overpayment to this account.

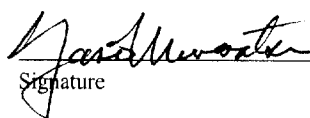
6. Total number of applications and patents involved: 1

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Yasuo Muramatsu

Name of Person Signing

 5/14/03

Signature

Date

38,684

Registration No.

Total number of pages including cover sheet, attachments and document: 2

Mail documents to be recorded with required cover sheet information to:

05/28/2003 ECOOPER 00000215 10373919

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40.00 OP

Assistant Commissioner for Patents

Box Assignments

Washington, D.C. 20231

ASSIGNMENT

WHEREAS, I, **Mitsue Nanbu**, a citizen of Japan, a resident of 1-32-1, Asahi-cho, Nerima-ku, Tokyo, 179 Japan, have invented certain new and useful improvements in **WAFER MAP DISPLAY APPARATUS AND METHOD FOR SEMICONDUCTOR TEST SYSTEM**, for which I filed an application for Letters Patent in the United States Patent and Trademark Office on February 25, 2003 with an assigned Application No. 10/373,919;

AND WHEREAS, **Advantest Corporation** (hereinafter "ASSIGNEE"), a Japanese corporation, with its principal place of business at NS Building, 4-1, Nishi-Shinjuku 2-chome, Shinjuku-ku, Tokyo, Japan, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in the receipt of valuable consideration which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and I do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

This 17 day of April 2003

南部 光江

Mitsue Nanbu